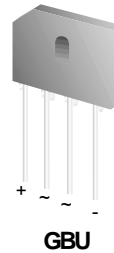




## GBU6A - GBU6M

### Features

- Glass passivated junction.
- Surge overload rating: 175 amperes peak.
- Reliable low cost construction utilizing molded plastic technique.
- Ideal for printed circuit board.
- UL certified, UL #E111753.



### Bridge Rectifiers

#### Absolute Maximum Ratings\*

$T_A = 25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Value							Units
		6A	6B	6D	6G	6J	6K	6M	
$V_{RRM}$	Maximum Repetitive Reverse Voltage	50	100	200	400	600	800	1000	V
$V_{RMS}$	Maximum RMS Bridge Input Voltage	35	70	140	280	420	560	700	V
$V_R$	DC Reverse Voltage (Rated $V_R$ )	50	100	200	400	600	800	1000	V
$I_{F(AV)}$	Average Rectified Forward Current, @ $T_A = 100^\circ\text{C}$	6.0							A
$I_{FSM}$	Non-repetitive Peak Forward Surge Current 8.3 ms Single Half-Sine-Wave	175							A
$T_{stg}$	Storage Temperature Range	-55 to +150							$^\circ\text{C}$
$T_J$	Operating Junction Temperature	-55 to +150							$^\circ\text{C}$

\*These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

### Thermal Characteristics

Symbol	Parameter	Value	Units
$P_D$	Power Dissipation	12	W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient,* per leg	18.6	$^\circ\text{C}/\text{W}$
$R_{\theta JL}$	Thermal Resistance, Junction to Lead,** per leg	3.1	$^\circ\text{C}/\text{W}$

\* Device mounted on PCB with 0.5 x 0.5" (12 x 12 mm).

\*\* Device mounted on Al plate with 2.6 x 1.4" x 0.06" (6.5 x 3.5 x 0.15 cm).

### Electrical Characteristics

$T_A = 25^\circ\text{C}$  unless otherwise noted

Symbol	Parameter	Device	Units
$V_F$	Forward Voltage, per element @ 6.0 A	1.0	V
$I_R$	Reverse Current, per element @ rated $V_R$ $T_A = 25^\circ\text{C}$ $T_A = 125^\circ\text{C}$	5.0 500	$\mu\text{A}$ $\mu\text{A}$
	$I^2t$ rating for fusing $t < 8.35$ ms	127	$\text{A}^2\text{s}$

Typical Characteristics

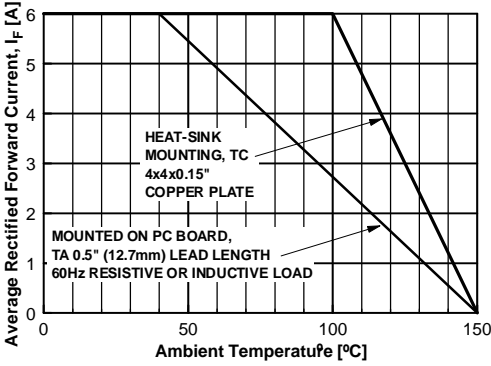


Figure 1. Forward Current Derating Curve

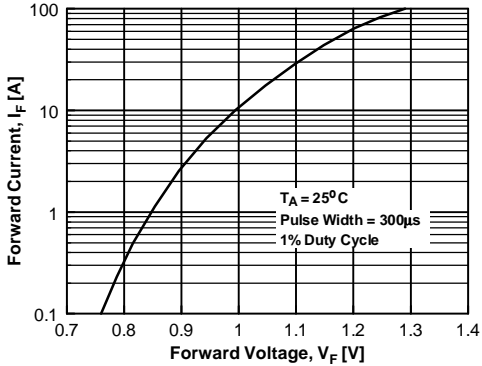


Figure 2. Forward Voltage Characteristics

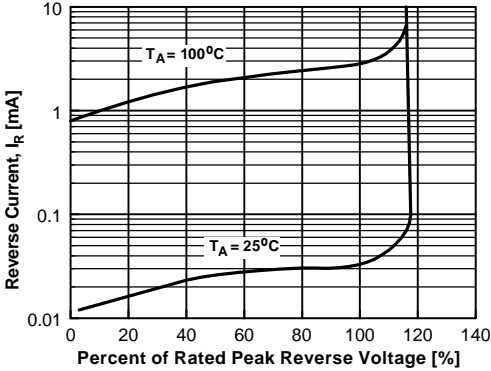


Figure 3. Reverse Current vs Reverse Voltage

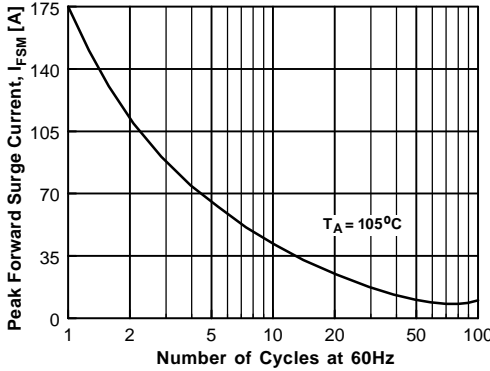


Figure 4. Non-Repetitive Surge Current

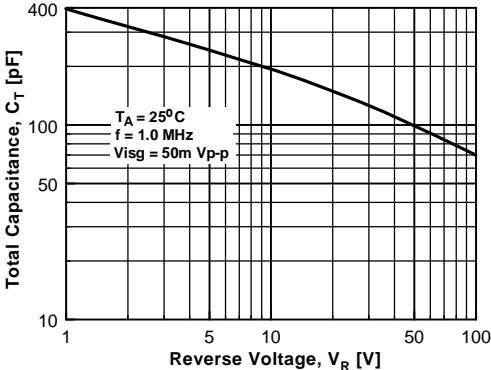


Figure 5. Total Capacitance

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